

Product Change Notification / GBNG-16BGIH897

Date:

27-Jan-2022

Product Category:

Ethernet Bridges, USB Hubs

PCN Type:

Manufacturing Change

Notification Subject:

CCB 4628 and 4628.001 Final Notice: Qualification of STA as an additional assembly site for selected LAN9500A, USB2512B, USB2513B, USB2514B and USX2064 device families available in 56L VQFN (8x8x0.9mm) and 36L VQFN (6x6x1.0mm) packages.

Affected CPNs:

GBNG-16BGIH897_Affected_CPN_01272022.pdf GBNG-16BGIH897_Affected_CPN_01272022.csv

Notification Text:

PCN Status: Final Notification

PCN Type:Manufacturing Change

Microchip Parts Affected:Please open one of the files found in the Affected CPNs section. Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

Description of Change:Qualification of STA as an additional assembly site for selected LAN9500A, USB2512B, USB2513B, USB2514B and USX2064 device families available in 56L VQFN (8x8x0.9mm) and 36L VQFN (6x6x1.0mm) packages.

Pre and Post Change Summary:

		Pre C	hange	Post Change				
	Assembly Site		Inc.	ASE	Inc.	STATS Chippac Ltd.		
Assemb			(ASE)		SE)	(STA)		
Wire	56L VQFN	PdCu	CuPdAu	PdCu	CuPdAu	CuPdAu		
material	36L VQFN	PdCu	Au	PdCu	Au	CUPUAU		
Die attach	Die attach material		EN-4900F		900F	8290		
	Molding compound material		G631B		31B	G700E		
	Material	C1	.94	C194		C194		
		-	40 mils	-	40 mils	236 x 236 mils ^{Note 1}		
Lead frame	Paddle size	-	.54 mils te 2	154 x 154 mils _{Note 2}		169 x 169 mils ^{Note} 2		
	Design	Se	e attached	Pre and P	ost Chang	e comparison.		

Note 1: Applicable for 56L VQFN package. Note 2: Applicable for 36L VQFN package.

Impacts to Data Sheet:None

Change ImpactNone

Reason for Change:To improve manufacturability by qualifying STA as an additional assembly site.

Change Implementation Status: In Progress

Estimated First Ship Date:October 31, 2021 (date code: 2145)

Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Time Table Summary:

	May 2021			>	October 2021			>	C)ecer	nber	202	1				
Workweek	19	20	21	22	23		41	42	43	44	45		49	50	51	52	53
Initial PCN Issue Date		x															
Qual Report Availability							x										

Final PCN Issue Date							x		
Estimated Implementation						x			
Date						~			

Method to Identify Change: Traceability code

Qualification Report:Please open the attachments included with this PCN labeled as PCN_#_Qual_Report.

Revision History: May 12, 2021: Issued initial notification.

October 8, 2021: Issued final notification. Provided estimated first ship date to be on October 31, 2021. Updated the estimated qualification completion date from August 2021 to December 2021. December 7, 2021: Re-issued final notification. Attached the Qualification Report. January 27, 2022: Re-issued final notification. Corrected lead frame drawing for ASE 36L VQFN in the Pre and Post Change summary attachment.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachments:

PCN_GBNG-16BGIH897_Pre_and_Post Change Summary.pdf PCN_GBNG-16BGIH897_Qual Report.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

Terms and Conditions:

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If you wish to <u>change your PCN profile, including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.



QUALIFICATION REPORT SUMMARY RELIABILITY LABORATORY

PCN #: GBNG-16BGIH897

Date: November 15, 2021

Qualification of STA as an additional assembly site for selected LAN9500A, USB2512B, USB2513B, USB2514B and USX2064 device families available in 56L VQFN (8x8x0.9mm) and 36L VQFN (6x6x1.0mm) packages.



Purpose CCB	Qualification of STA as an additional assembly site for selected LAN9500A, USB2512B, USB2513B, USB2514B and USX2064 device families available in 56L VQFN (8x8x0.9mm) and 36L VQFN (6x6x1.0mm) packages. 4628 and 4628.001
CN	ES361343
QUAL ID	R2100819 Rev. A
MP CODE	XG571SRTXB0C
Part No.	LAN9500A-ABZJ-TR
Bonding No.	BDM-002967 Rev. A
<u>Package</u>	
Туре	56L VQFN
Package size	8x8x0.9 mm
Lead Frame	
Paddle size	236 x 236 mils
Material	C194
Surface	Double Ring
Process	Etched
Lead Lock	No
Part Number	R002-3646X
<u>Material</u>	
Ероху	8290
Wire	CuPdAu wire
Mold Compound	G700E
Plating Composition	Matte Sn



Manufacturing Information

Assembly Lot No.	Wafer Lot No.	Date Code
STA-221300020.000	GF07922071569.100	21256RJ
STA-221300022.000	GF07922071569.100	21266RQ
STA-221300021.000	GF07922071569.100	21256RK

Result

X Pass

Fail

56L VQFN (8x8x0.9 mm) assembled by STA pass reliability test per QCI-39000. This package was qualified the Moisture/Reflow Sensitivity Classification Level 3 at 260°C reflow temperature per IPC/JEDEC J-STD-020E standard.

PACKAGE QUALIFICATION REPORT										
Test Number (Reference)	Test Condition	Standard/ Method	Qty. (Acc.)	Def/SS	Result	Remarks				
Precondition Prior Perform	Electrical Test: +25°C and 100°C System: EX_ANALOG	JESD22- A113	693(0)	693		Good Devices				
<u>Reliability Tests</u> (At MSL Level 3)	Bake 150°C, 24 hrs System: CHINEE	JIP/ IPC/JEDEC		693						
	30°C/60%RH Moisture Soak 192 hrs. System: TABAI ESPEC Model PR-3SPH	J-STD-020E		693						
	3x Convection-Reflow 265°C max			693						
	System: Vitronics Soltec MR1243									
	Electrical Test: +25°C and 100°C System: EX_ANALOG			0/693	Pass					

	PACKAGE QUALIF	ICATION	REP	ORT		
Test Number (Reference)	Test Condition	Standard/ Method	Qty. (Acc.)	Def/SS.	Result	Remarks
	Stress Condition: -65°C to +150°C, 500 Cycles System: TABAI ESPEC TSA-70H	JESD22- A104		231		Parts had been pre-conditioned at 260°C
	Electrical Test: +100°C System: EX_ANALOG		231(0)	0/231	Pass	77 units / lot
Temp Cycle	Stress Condition: -65°C to +150°C, 1000 Cycles System: TABAI ESPEC TSA-70H			231		
	Electrical Test: +100°C System: EX_ANALOG		231(0)	0/231	Pass	
	Bond Strength: Wire Pull (> 3.00 grams)		15 (0)	0/15	Pass	
	Bond Shear (> 8.00 grams)		15 (0)	0/15	Pass	
	Stress Condition: +130°C/85%RH, 96 hrs. System: HAST 6000X	JESD22- A118		231		Parts had been pre-conditioned at 260°C
	Electrical Test: +25°C System: EX_ANALOG		231(0)	0/231	Pass	77 units / lot
UNBIASED- HAST	Stress Condition: +130°C/85%RH, 192 hrs. System: HAST 6000X			231		
	Electrical Test: +25°C System: EX_ANALOG		231(0)	0/231	Pass	

	PACKAGE QUALIFIC		I REF	PORT	•	
Test Number (Reference)	Test Condition	Standard/ Method	Qty. (Acc.)	Def/SS.	Result	Remarks
High Temperature Storage Life	Stress Condition: Bake 175°C, 504 hrs System: SHEL LAB	JESD22- A103		45		45 units
	Electrical Test: +25°C and 100°C System: EX_ANALOG		45(0)	0/45	Pass	
Solderability	Steam Aging: Temp 93°C,8Hrs System: SAS-3000	J-STD-002	22 (0)	22		
Temp 245°C	Solder Dipping:Solder Temp.245°C Solder material:Pb Free Sn 95.5Ag3.9 Cu0.6 System: ERSA RA 2200D Visual Inspection: External Visual Inspection			22 0/22	Pass	
Physical	Physical Dimension,	JESD22-	30(0)	0/30	Pass	
Dimensions	10 units from 1 lot	B100/B108	Units			
Bond Strength	Wire Pull (> 3.00 grams)	Mil. Std. 883-2011	30 (0) Wires	0/30	Pass	
Data Assembly	Bond Shear (> 8.00 grams)	CDF-AEC- Q100-001	30 (0) bonds	0/30	Pass	

CCB 4628 and 4628.001 Pre and Post Change Summary PCN #: GBNG-16BGIH897

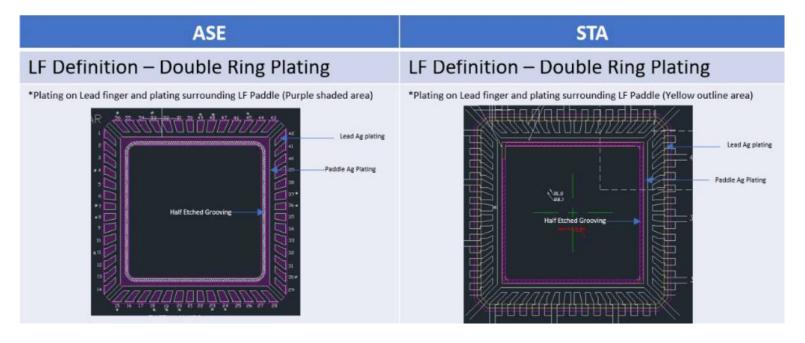


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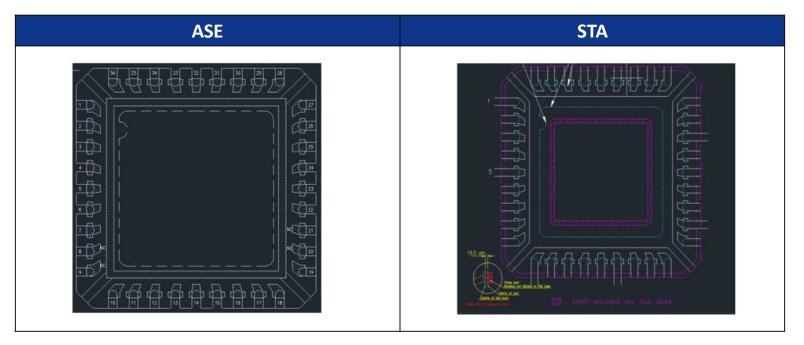
Lead frame Comparison 56L VQFN

2





Lead frame Comparison 36L VQFN





3

GBNG-16BGIH897 - CCB 4 USB2512B USB2513B USB2514B and USX2064 device families available in 56L V

Affected Catalog Part Numbers(CPN)

USB2512B-AEZG USB2513B-AEZG USB2513B-AEZC USB2514B-AEZG USB2514B-AEZC USB2512BI-AEZG USB2513BI-AEZG USB2514BI-AEZG USB2512B-AEZG-TR USB2513B-AEZG-TR-CD0 USB2513B-AEZG-TR USB2513B-AEZC-TR USB2514B-AEZG-TR USB2514B-AEZC-TR USX2064-AEZG-TR USB2512BI-AEZG-TR USB2513BI-AEZG-TR USB2514BI-AEZG-TR USX2064I-AEZG-TR LAN9500A-ABZJ LAN9500AI-ABZJ LAN9500A-ABZJ-TR LAN9500AI-ABZJ-TR LAN9500AI-ABZJ-TR-SEU